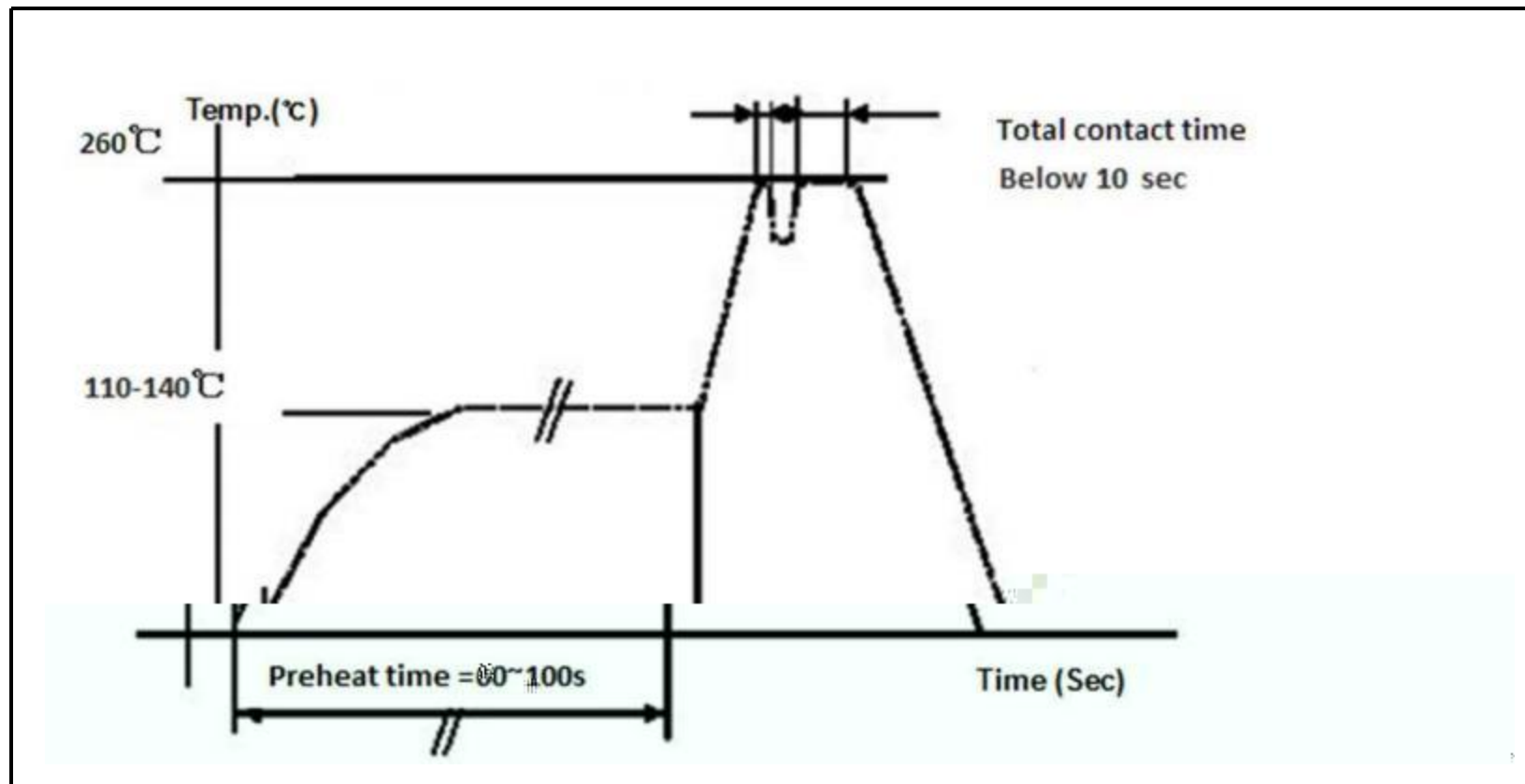
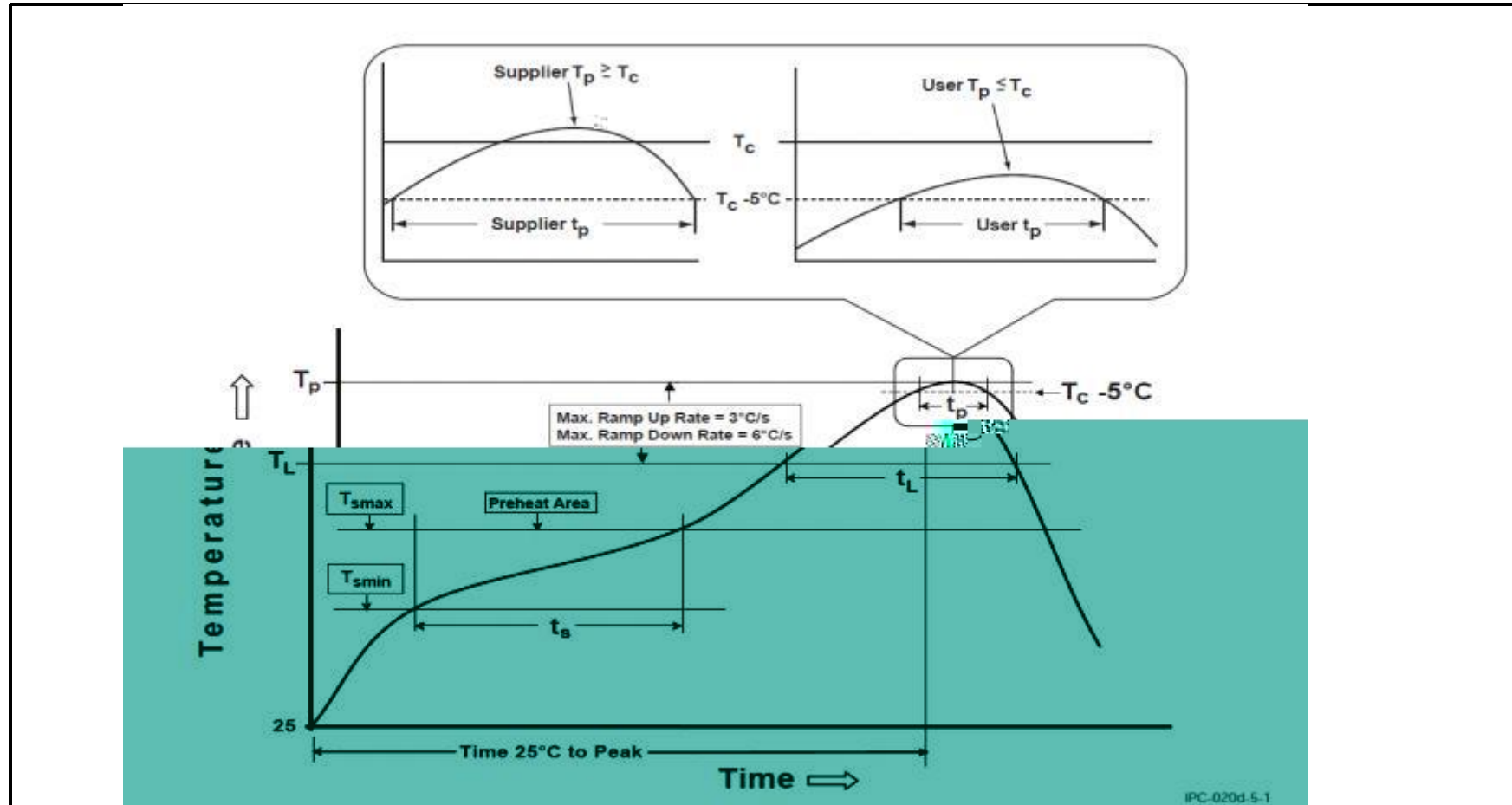








Melting Point of Solder (Sn Ag Cu)	217
Ramp-up Rate to 217 (Melting Point of Solder)	3 /sec
Time at Temp.>217 (Melting Point of Solder)	60~150 Sec
Peak Temperature	255±5
Time within 5 below Peak Temp.	20~40 Sec
Cooling Rate	6 /sec (max)
Time from 25 to Peak Temp.	8min (max)



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